

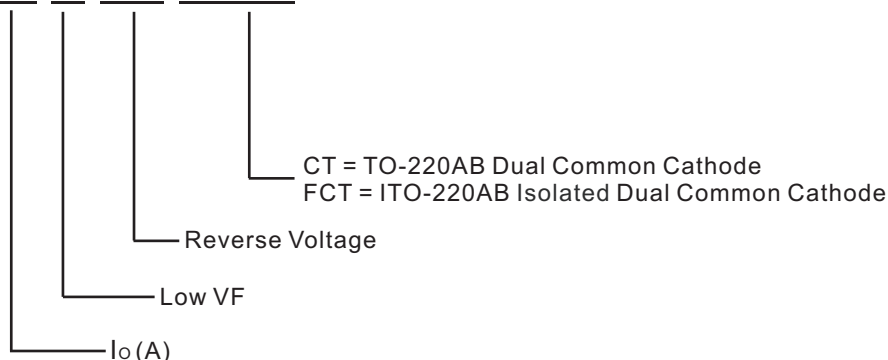
MBR40L60CT / MBR40L60FCT

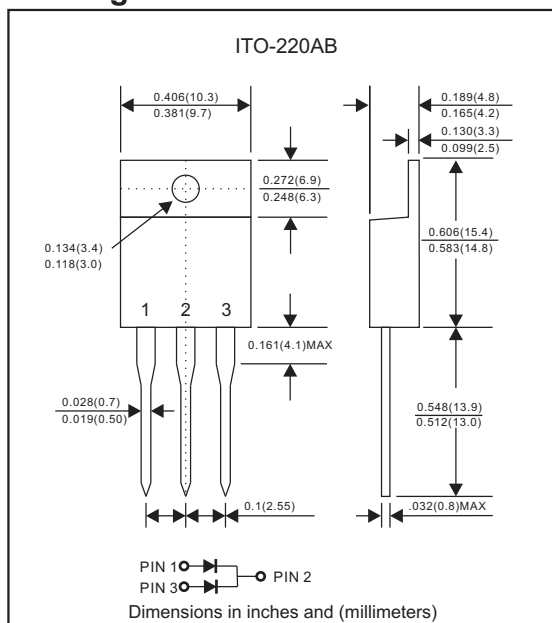
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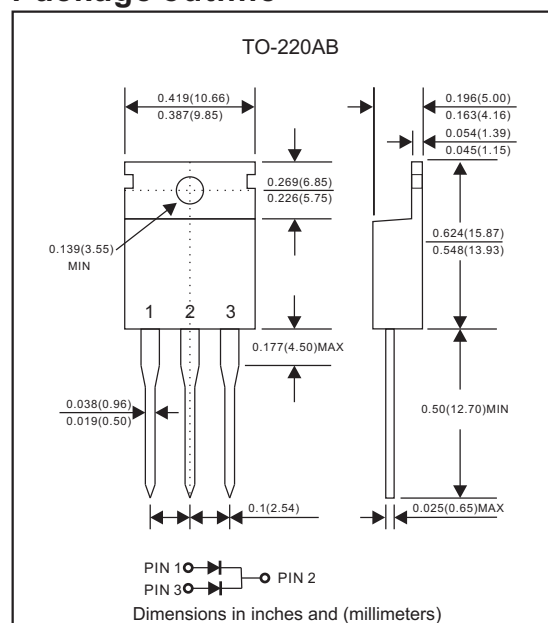
Part Nomenclature

MBR40 L 60 XXX



MBR40L60CT / MBR40L60FCT**40A High Barrier Low VF Power Schottky Rectifiers - 60V****Package outline****Features**

- High current density schottky.
- 150°C operating junction temperature.
- Offer 20A half wave and 40A full wave rectification.
- Low power loss, high efficiency.
- Low forward voltage drop.
- High current capability
- High surge capability.
- Lead-free parts meet RoHS requirments.
- Suffix "-H" indicates Halogen-free part, ex.MBR40L60CT-H.

Package outline**Mechanical data**

- Epoxy : UL94-V0 rated flame retardant
- Case : JEDEC ITO-220AB or TO-220AB molded plastic body over passivated chip
- Lead : Axial leads, solderable per MIL-STD-202, Method 208 guranteed
- Polarity: As marked
- Mounting Position : Any
- Weight : ITO-220AB Approximated 1.70 gram
- Weight : TO-220AB Approximated 2.10 gram

Maximum ratings (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	Symbol	MBR40L60CT	MBR40L60FCT	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	60		Volts
Maximum RMS voltage	V_{RMS}	42		Volts
Maximum DC blocking voltage	V_{DC}	60		Volts
Maximum average forward rectified current See Fig.1	I_O	40		A
Peak forward surge current 8.3ms single half sine-wave	I_{FSM}	300		A
Operating junction temperature range	T_J	-65 to +150		°C
Storage temperature range	T_{STG}	-65 to +150		°C

Electrical characteristics (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	Symbol	MBR40L60CT	MBR40L60FCT	Unit
Maximum forward voltage per leg at $I_F=20\text{A}$ $T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$ at $I_F=40\text{A}$ $T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	V_F	0.55 0.53 0.78 0.75		Volts
Maximum reverse current at rated V_{DC} per leg $T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	I_R	0.25 50		mA

Thermal characteristics

PARAMETER	Symbol	MBR40L60CT	MBR40L60FCT	Unit
Typical thermal resistance junction to case per leg	$R_{\theta JC}$	2.0	4.0	°C/W

Rating and characteristic curves (MBR40L60CT / MBR40L60FCT)

Fig. 1 - Forward Current Derating Curve

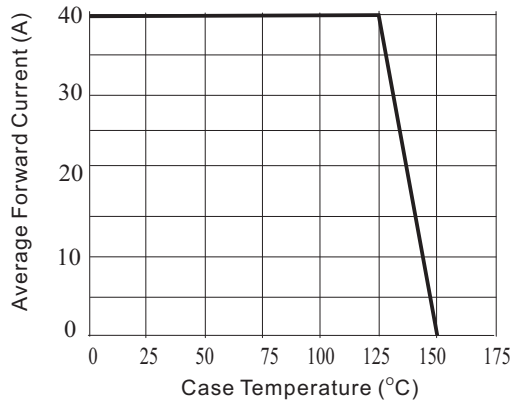


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

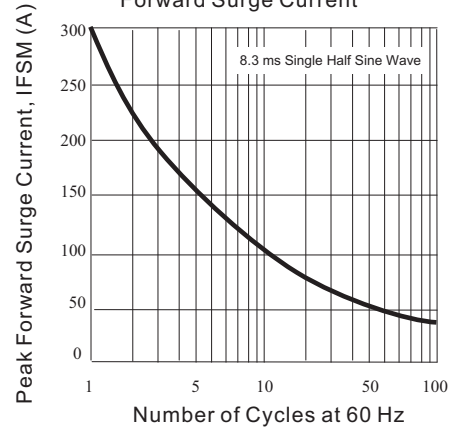


Fig. 3 - Typical Forward Characteristics

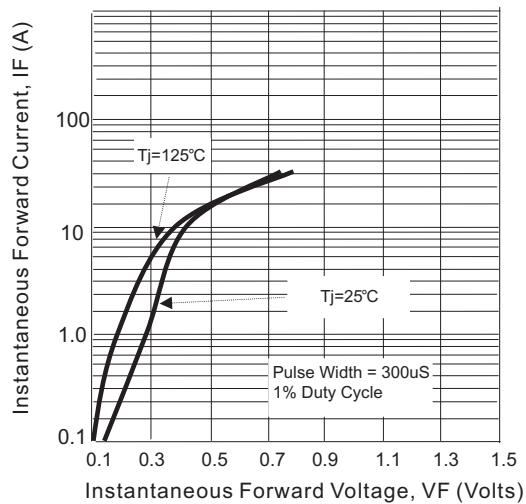
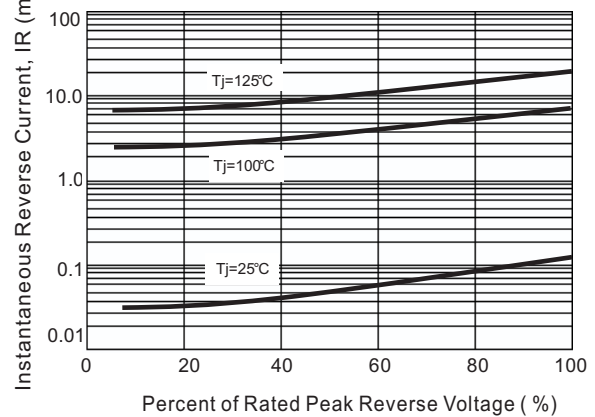
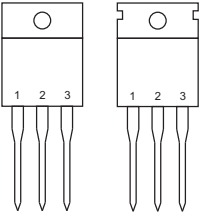
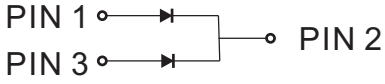


Fig. 4 - Typical Reverse Characteristics



MBR40L60CT / MBR40L60FCT**Pinning information**

Pin	Simplified outline	Symbol
Pin1 anode Pin2 cathode Pin3 anode		

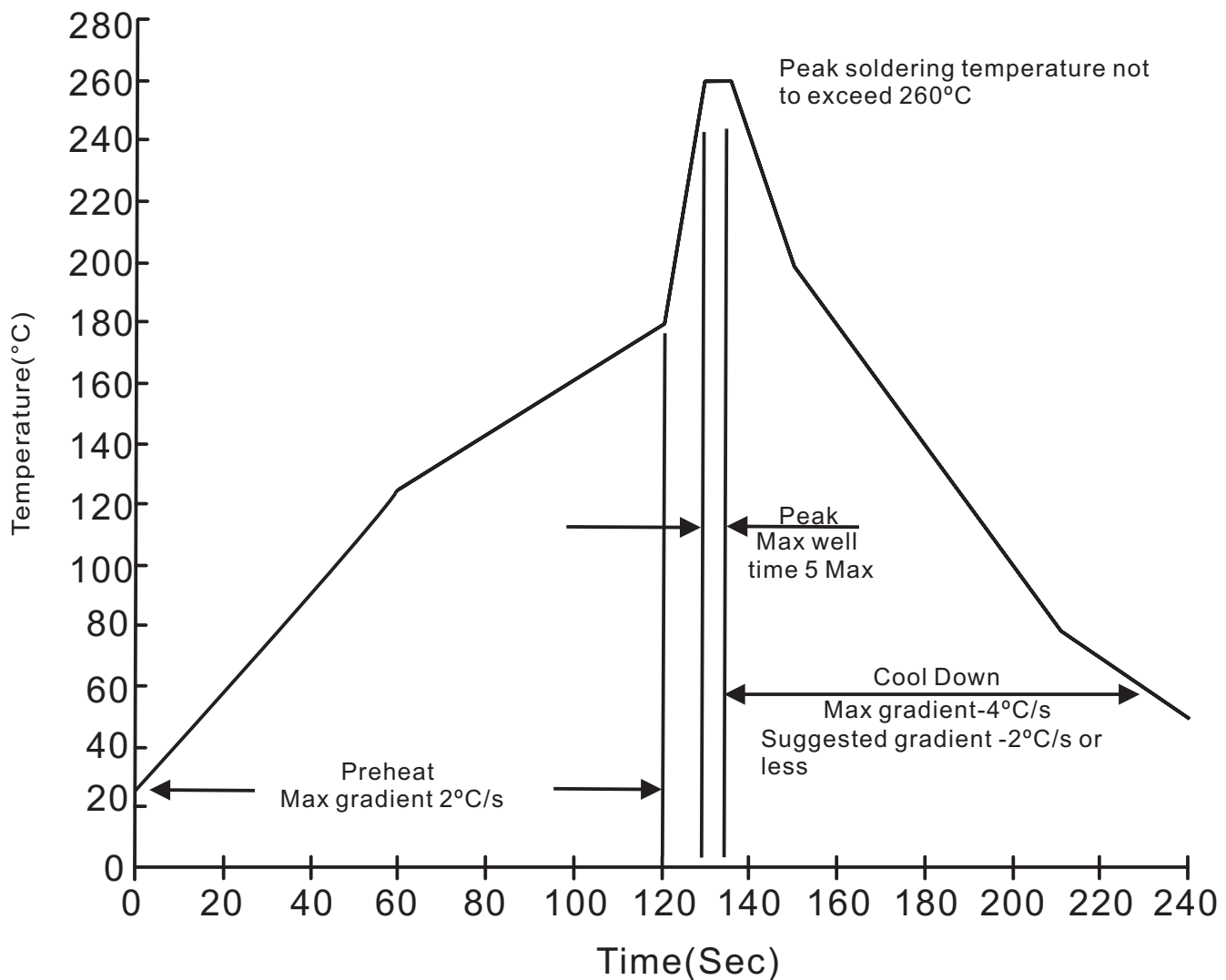
Marking

Type number	Marking code
MBR40L60CT	MBR40L60CT
MBR40L60FCT	MBR40L60FCT

Tube packing

PACKAGE	TUBE (pcs)	TUBE SIZE (m/m)	BOX (pcs)	INNER BOX (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
ITO-220AB	50	525*32*7.0	1,000	555*150*40	580*230*175	5,000	15.0

PACKAGE	TUBE (pcs)	TUBE SIZE (m/m)	BOX (pcs)	INNER BOX (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
TO-220AB	50	525*32*7.5	1,000	555*150*40	580*230*175	5,000	15.0

MBR40L60CT / MBR40L60FCT**Suggested thermal profiles for soldering processes****1. Lead free temperature profile wave-soldering**

MBR40L60CT / MBR40L60FCT**High reliability test capabilities**

Item Test	Conditions	Reference
1. Solder Resistance	at $260 \pm 5^{\circ}\text{C}$ for $10 \pm 2\text{sec.}$ immerse body into solder $1/16" \pm 1/32"$	MIL-STD-750D METHOD-2031
2. Solderability	at $245 \pm 5^{\circ}\text{C}$ for 5 sec.	MIL-STD-202F METHOD-208
3. High Temperature Reverse Bias	$V_R = 80\%$ rate at $T_J = 150^{\circ}\text{C}$ for 168 hrs.	MIL-STD-750D METHOD-1038
4. Forward Operation Life	Rated average rectifier current at $T_A = 25^{\circ}\text{C}$ for 500hrs.	MIL-STD-750D METHOD-1027
5. Intermittent Operation Life	$T_A = 25^{\circ}\text{C}$, $I_F = I_O$ On state: power on for 5 min. off state: power off for 5 min. on and off for 500 cycles.	MIL-STD-750D METHOD-1036
6. Pressure Cooker	$15P_{SIG}$ at $T_A = 121^{\circ}\text{C}$ for 4 hrs.	JESD22-A102
7. Temperature Cycling	-55°C to $+125^{\circ}\text{C}$ dwelled for 30 min. and transferred for 5min. total 10 cycles.	MIL-STD-750D METHOD-1051
8. Forward Surge	8.3ms single half sine-wave , one surge.	MIL-STD-750D METHOD-4066-2
9. Humidity	at $T_A = 85^{\circ}\text{C}$, RH=85% for 1000hrs.	MIL-STD-750D METHOD-1021
10. High Temperature Storage Life	at 175°C for 1000 hrs.	MIL-STD-750D METHOD-1031